CRMGGL1210A

N-Channel 120V, 10.2mΩ Typ. Power MOSFET

Description

Features

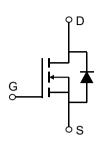
• 120V, 75A

$$R_{DS(ON)}$$
 Typ = 10.2m Ω @ V_{GS} = 10 V

 $R_{DS(ON)}$ Typ = 13.8m Ω @ V_{GS} = 4.5V

Advanced Split Gate Trench Technology

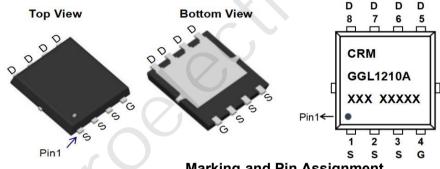
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!





Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGL1210A	CRMGGL1210A	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		120	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	75	А
I _D	Continuous Diam Current	T _C = 100°C	45	А
I _{DM}	Pulsed Drain Current (1)		300	А
E _{AS}	Single Pulsed Avalanche Energy (2)		127	mJ
P_{D}	Power Dissipation	T _C = 25°C	125	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1	°C/W
T _J , T _{STG}	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	120	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.4	2	2.6	V
В	Chatia Dania Conner ON Desister (3)	$V_{GS} = 10V, I_D = 30A$	-	10.2	13.3	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 4.5V, I_D = 30A$	-	13.8	18	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(2092	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 60V,$ f = 1MHz	X-\	565	-	pF
C_{rss}	Reverse Transfer Capacitance	1 – 1101112	-	4	-	pF
Q_g	Total Gate Charge		J .	27	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 60V, I_{D} = 30A$	-	5	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 00 V, I _D - 30A	-	6.3	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime	.r ()	-	19	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 60V$	-	8	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 30A$, $R_{GEN} = 3\Omega$	-	72	-	ns
t_{f}	Turn-Off Fall Time		-	94	-	ns
Drain-So	urce Diode Characteristics and N	Max Ratings				
Is	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	75	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	300	А
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I 00A 17/11 400A7	-	52	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 30A$, di/dt = 100A/us	_	113	_	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =60V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =22.5A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

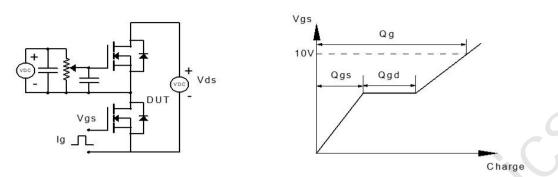


Figure 1: Gate Charge Test Circuit & Waveform

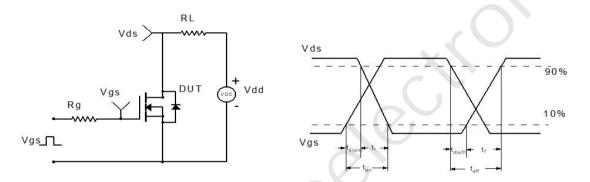


Figure 2: Resistive Switching Test Circuit & Waveform

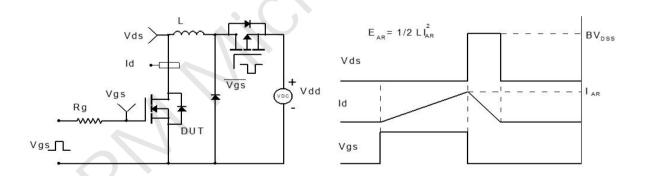


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

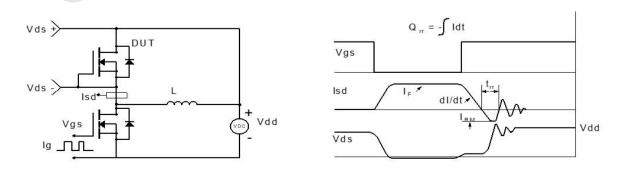
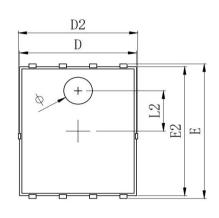


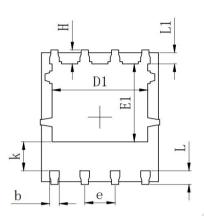
Figure 4: Diode Recovery Test Circuit & Waveform

CRMGGL1210A

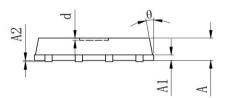
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Package Mechanical Data(PDFN5x6-8L)





SYMBOL	MILLIMETER				
	MIN	Тур.	MAX		
A	0. 900	1.000	1. 100		
A1	0.254 REF.				
A2	0~0.05				
D	4. 824	4. 900	4. 976		
D1	3. 910	4.010	4. 110		
D2	4. 924	5. 000	5. 076		
E	5. 924	6.000	6. 076		
E1	3. 375	3. 475	3. 575		
E2	5. 674	5. 750	5. 826		
b	0. 350	0. 400	0. 450		
е	1.270 TYP.				
L	0. 534	0. 610	0. 686		
L1	0. 424	0. 500	0. 576		
L2	1.800 REF.				
k	1. 190	1. 290	1. 390		
Н	0. 549	0. 625	0. 701		
θ	8°	10°	12°		
ф	1.100	1.200	1.300		
d			0. 100		



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Contact information

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